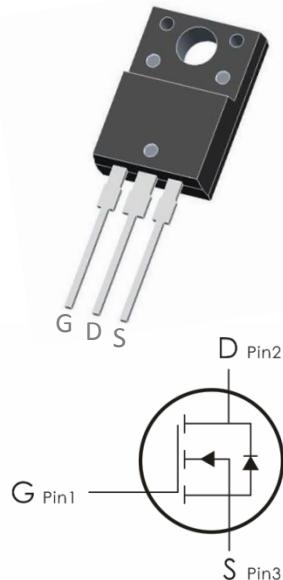


## Description:

This N-Channel MOSFET uses advanced trench technology and design to provide excellent  $R_{DS(on)}$  with low gate charge. It can be used in a wide variety of applications.

## Features:

- 1)  $V_{DS}=500V, I_D=5A, R_{DS(on)}<1.4 \Omega @ V_{GS}=10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra low  $R_{DS(on)}$ .
- 5) Excellent package for good heat dissipation.



## Absolute Maximum Ratings: ( $T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain-Source Voltage	500	V
$V_{GS}$	Gate-Source Voltage	$\pm 30$	V
$I_D$	Continuous Drain Current- $T_C=25^\circ C$	5	A
	Continuous Drain Current- $T_C=100^\circ C$	2.2	
$E_{AS}$	Single Pulse Avalanche Energy <sup>1</sup>	270	mJ
$P_D$	Power Dissipation	35	W
$I_{AR}$	Avalanche Current <sup>2</sup>	5	A
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	°C

## Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{eJC}$	Thermal Resistance,Junction to Case	3.45	°C/W
$R_{eJA}$	Thermal Resistance,Junction to Ambient	110	

**Electrical Characteristics:** ( $T_c=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250 \mu\text{A}$	500	---	---	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=500\text{V}$	---	---	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 30\text{V}, V_{\text{DS}}=0\text{A}$	---	---	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{\text{GS}(\text{th})}$	GATE-Source Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250 \mu\text{A}$	2	---	4	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=2.5\text{A}$	---	---	1.4	$\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=25, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	800	1000	pF
$C_{\text{oss}}$	Output Capacitance		---	75	95	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	8.5	11	
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DS}}=250\text{V}, I_{\text{D}}=5\text{A}$	---	13	35	ns
$t_r$	Rise Time		---	55	120	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		---	25	60	ns
$t_f$	Fall Time		---	35	80	ns
$Q_g$	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=400\text{V}$	---	13	17	nC
$Q_{\text{gs}}$	Gate-Source Charge		---	3.4	---	nC
$Q_{\text{gd}}$	Gate-Drain "Miller" Charge		---	6.4	---	nC
<b>Drain-Source Diode Characteristics</b>						
$V_{\text{SD}}$	Source-Drain Diode Forward Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=5\text{A}$	---	---	1.5	V
$I_s$	Max. Diode Forward Current	---	---	---	5	A
$I_{\text{sm}}$	Max. Pulsed Forward Current		---	---	20	A

<b>Trr</b>	Reverse Recovery Time	$I_S=5A, V_{GS}=0V$ $dI/dt=100A/\mu s$ (Note3)	---	215	---	Ns
<b>qrr</b>	Reverse Recovery Charge		---	1.26	---	nc

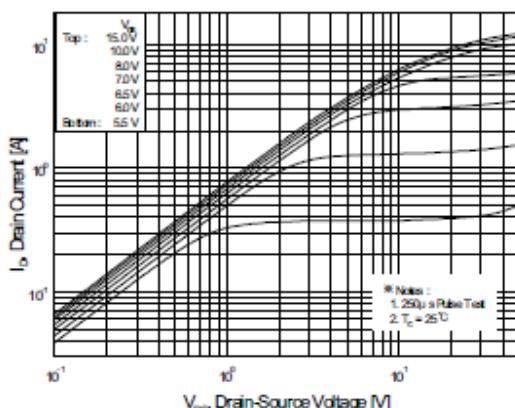
Notes : 1, L=27mH, IAS=5A, VDD=50V, RG=25Ω, Starting TJ =25°C

2, Repetitive Rating : Pulse width limited by maximum junction temperature

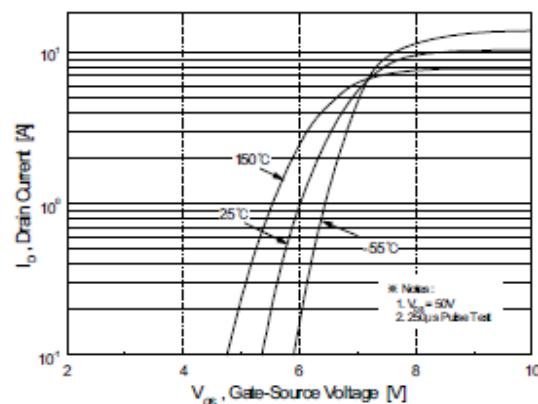
3, Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 2%

4, Essentially Independent of Operating Temperature

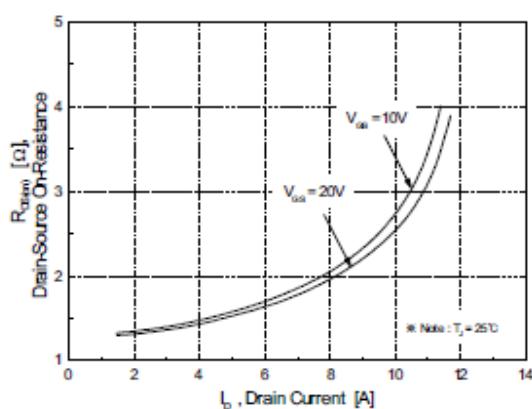
**Typical Characteristics:** ( $T_c=25^\circ C$  unless otherwise noted)



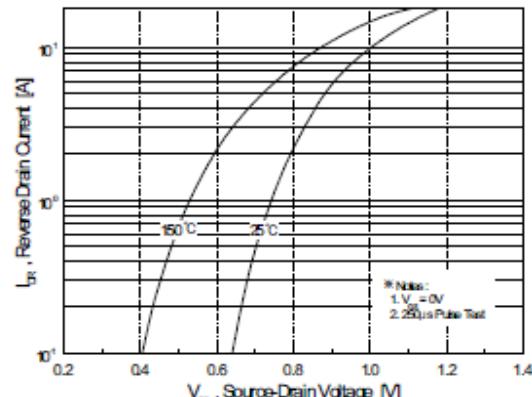
**Figure 1. On-Region Characteristics**



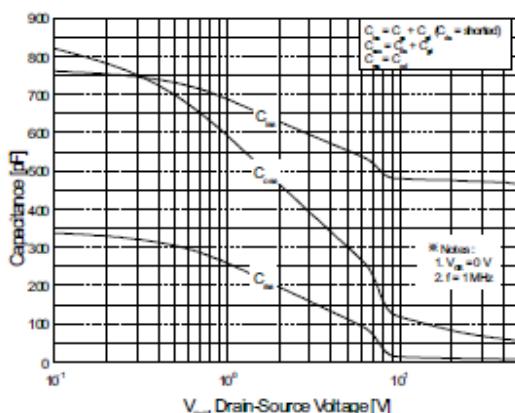
**Figure 2. Transfer Characteristics**



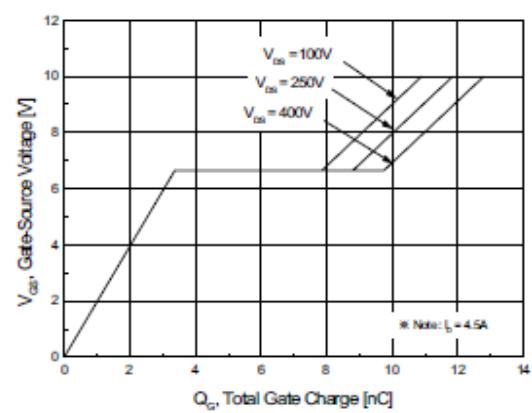
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**



**Figure 5. Capacitance Characteristics**



**Figure 6. Gate Charge Characteristics**

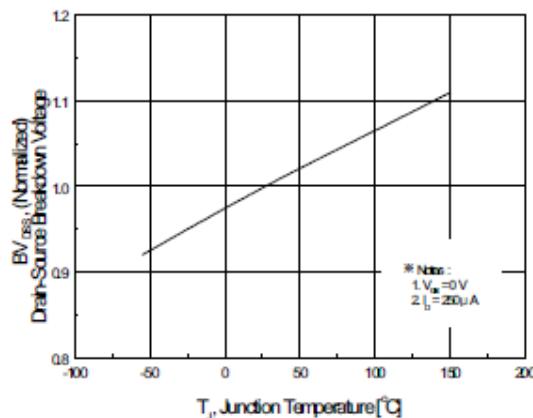


Figure 7. Breakdown Voltage Variation  
vs. Temperature

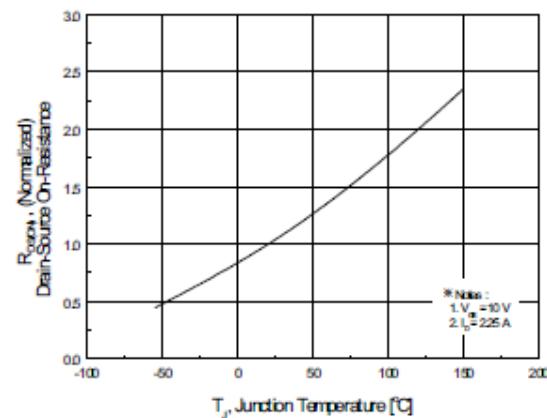


Figure 8. On-Resistance Variation  
vs. Temperature

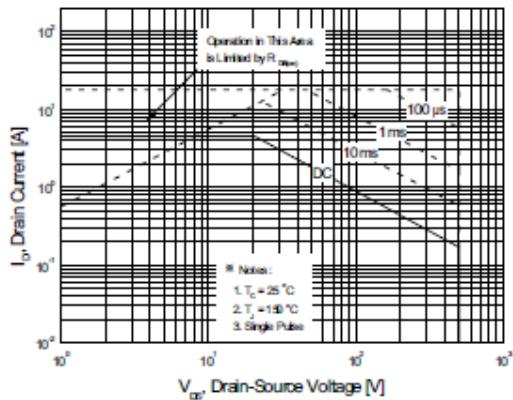


Figure 9. Maximum Safe Operating Area

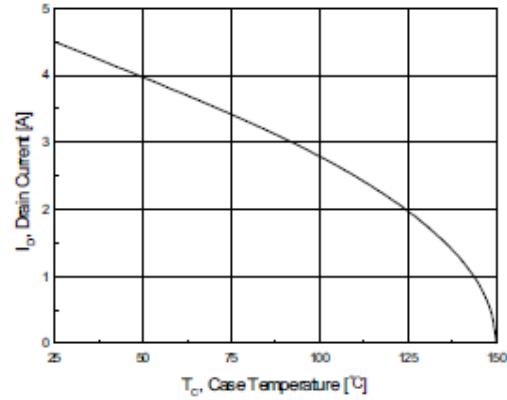


Figure 10. Maximum Drain Current  
vs. Case Temperature

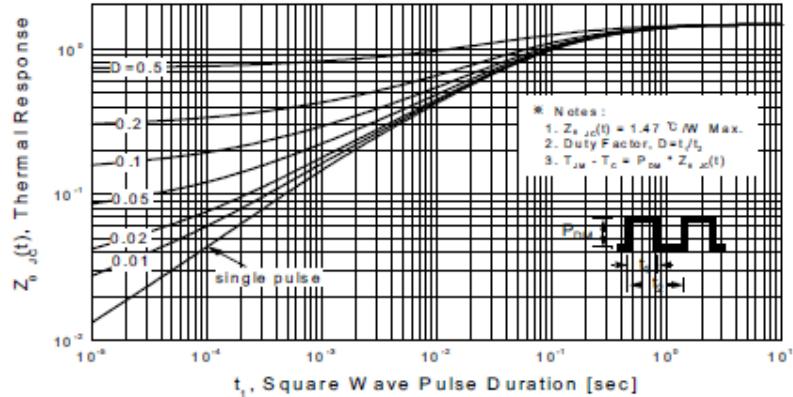


Figure 11. Transient Thermal Response Curve



0086-0755-8278-9056  
www.doingter.cn